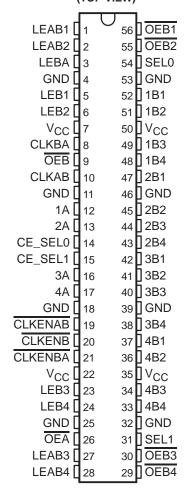
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- Members of the Texas Instruments
 Widebus™ Family
- State-of-the-Art EPIC-IIB™ BiCMOS Design Significantly Reduces Power Dissipation
- Latch-Up Performance Exceeds 500 mA Per JEDEC Standard JESD-17
- Typical V_{OLP} (Output Ground Bounce)
 1 V at V_{CC} = 5 V, T_A = 25°C
- High-Impedance State During Power Up and Power Down
- Distributed V_{CC} and GND Pin Configuration Minimizes High-Speed Switching Noise
- Flow-Through Architecture Optimizes PCB Layout
- High-Drive Outputs (–32-mA I_{OH}, 64-mA I_{OL})
- Bus Hold on Data Inputs Eliminates the Need for External Pullup/Pulldown Resistors
- Package Options Include Plastic 300-mil Shrink Small-Outline (DL) and Thin Shrink Small-Outline (DGG) Packages and 380-mil Fine-Pitch Ceramic Flat (WD) Package Using 25-mil Center-to-Center Spacings

description

The 'ABTH16460 are 4-bit to 1-bit multiplexed registered transceivers used in applications where four separate data paths must be multiplexed onto or demultiplexed from a single data path. Typical applications include multiplexing and/or demultiplexing of address and data information in microprocessor or bus-interface applications. These devices also are useful in memory-interleaving applications.

SN54ABTH16460 . . . WD PACKAGE SN74ABTH16460 . . . DGG OR DL PACKAGE (TOP VIEW)



Five 4-bit I/O ports (1A-4A, 1B1-4, 2B1-4, 3B1-4, and 4B1-4) are available for address and/or data transfer. The output-enable (OEB, OEB1-OEB4, and OEA) inputs control the bus-transceiver functions. These control signals also allow 4-bit or 16-bit control, depending on the OEB level.



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description (continued)

Address and/or data information can be stored using the internal storage latches/flip-flops. The latch-enable (LEB1–LEB4, LEBA, and LEAB1–LEAB4) and clock/clock-enable (CLK/CLKEN) inputs are used to control data storage. When either one of the latch-enable inputs is high, the latch is transparent (clock is a don't care as long as the latch enable is high). When the latch-enable input goes low (providing that the clock does not transit from low to high), the data present at the inputs is latched and remains latched until the latch-enable input is returned high. When the clock enable is low and the corresponding latch enable is low, data can be clocked on the low-to-high transition of the clock. When either the clock enable or the corresponding latch enable is high, the clock is a don't care.

Four select pins (SEL0, SEL1, CE_SEL0, and CE_SEL1) are provided to multiplex data (A port), or to select one of four clock enables (B port). This allows the user the flexibility of controlling one bit at a time.

Active bus-hold circuitry is provided to hold unused or floating data inputs at a valid logic level.

When V_{CC} is between 0 and 2.1 V, the device is in the high-impedance state during power up or power down. However, to ensure the high-impedance state above 2.1 V, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The SN54ABTH16460 is characterized for operation over the full military temperature range of –55°C to 125°C. The SN74ABTH16460 is characterized for operation from –40°C to 85°C.

Function Tables

A-TO-B OUTPUT ENABLET

| INP | UTS | OUTPUT |
|-----|------|--------|
| OEB | OEBn | Bn |
| Н | Н | Z |
| Н | L | Z |
| L | Н | Z |
| L | L | Active |

 $\dagger n = 1, 2, 3, 4$

A-TO-B STORAGE (assuming OEB = L, OEBn = L)‡

| INPUTS | | | | | | | | | OUTI | PUTS | |
|---------|---------|---------|------------|-------|-------|-------|-------|----------------|----------------|----------------|----------------|
| CLKENAB | CE_SEL1 | CE_SEL0 | CLKAB | LEAB1 | LEAB2 | LEAB3 | LEAB4 | B1 | B2 | В3 | В4 |
| Х | Х | Х | H or L | Н | L | L | L | Α | A ₀ | A ₀ | A ₀ |
| Х | Χ | Χ | H or L | Н | Н | Н | L | Α | Α | Α | A ₀ |
| L | Χ | Χ | L | L | L | L | L | A ₀ | A ₀ | A ₀ | A ₀ |
| L | L | L | \uparrow | L | L | L | L | Α | A_0 | A_0 | A ₀ |
| L | L | Н | \uparrow | L | L | L | L | A ₀ | Α | A_0 | A ₀ |
| L | Н | L | \uparrow | L | L | L | L | A ₀ | A ₀ | Α | A ₀ |
| L | Н | Н | \uparrow | L | L | L | L | A ₀ | A ₀ | A_0 | Α |
| Н | Χ | Χ | \uparrow | L | L | L | L | A ₀ | A ₀ | A ₀ | A ₀ |

[‡]This table does not cover all the latch-enable cases since they have similar results.



SN54ABTH16460, SN74ABTH16460 4-TO-1 MULTIPLEXED/DEMULTIPLEXED TRANSCEIVERS WITH 3-STATE OUTPUTS SCBS207F - OCTOBER 1992 - REVISED MAY 1997

Function Tables (Continued)

B-TO-A STORAGE (before point P)

| INPUTS | | | | | | | | Р |
|--------|----------|------|------|------|------|------|------|-------------------|
| CLKENB | CLKBA | LEB1 | LEB2 | LEB3 | LEB4 | SEL1 | SEL0 | P |
| Х | Х | Н | L | L | L | L | L | B1 |
| Х | X | L | Н | L | L | L | Н | B2 |
| X | X | L | L | Н | L | Н | L | В3 |
| Х | X | L | L | L | Н | Н | Н | В4 |
| | | | | | | L | L | B1 |
| ١. | ↑ | | | | | L | Н | B2 |
| _ | ı | L | L | L | L | Н | L | В3 |
| | | | | | | Н | Н | В4 |
| | | | | | | L | L | В1 ₀ † |
| ١, | | | | | ı | L | Н | в2 ₀ † |
| | L | L | L | L | L | Н | L | вз ₀ † |
| | | | | | | Н | Н | в4 ₀ † |

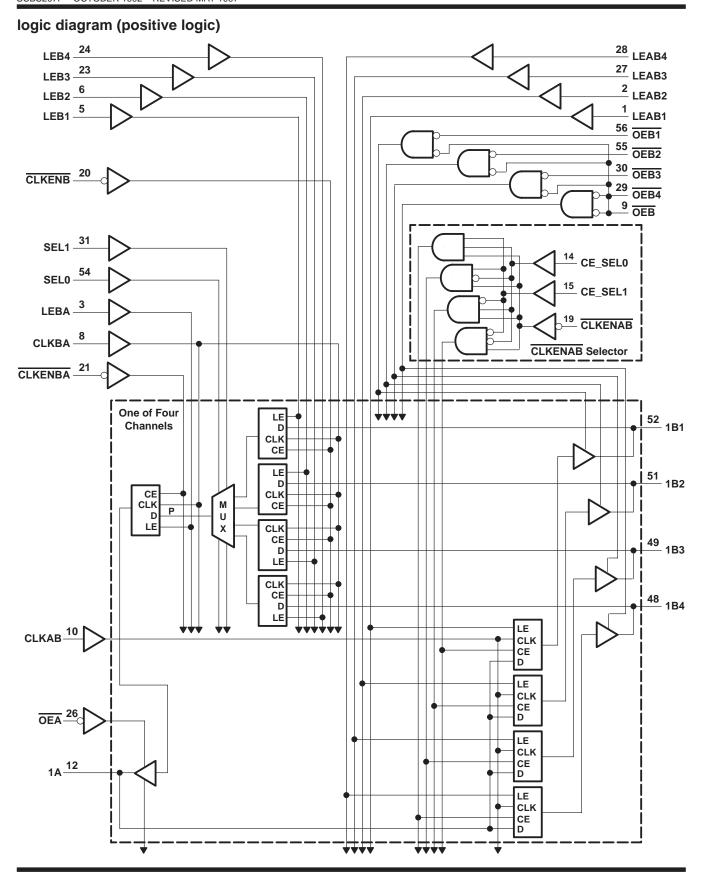
[†] Output level before the indicated steady-state input conditions were established

B-TO-A STORAGE (after point P)

| (arter point i) | | | | | | | | | | |
|-----------------|------------|------|-----|---|------------------|--|--|--|--|--|
| | INPUTS | | | | | | | | | |
| CLKENBA | CLKBA | LEBA | OEA | В | Α | | | | | |
| Х | Χ | Х | Н | Χ | Z | | | | | |
| Х | X | Н | L | L | L | | | | | |
| Х | X | Н | L | Н | Н | | | | | |
| Н | X | L | L | Χ | A ₀ † | | | | | |
| L | \uparrow | L | L | L | L | | | | | |
| L | \uparrow | L | L | Н | Н | | | | | |
| L | L | L | L | X | A ₀ † | | | | | |

[†] Output level before the indicated steady-state input conditions were established

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

| Supply voltage range, V _{CC} | 0.5 V to 7 V |
|--|-----------------|
| Input voltage range, V _I (except I/O ports) (see Note 1) | –0.5 V to 7 V |
| Voltage range applied to any output in the high or power-off state, VO | –0.5 V to 5.5 V |
| Current into any output in the low state, IO: SN54ABTH16460 | 96 mA |
| SN74ABTH16460 | 128 mA |
| Input clamp current, I _{IK} (V _I < 0) | –18 mA |
| Output clamp current, I _{OK} (V _O < 0) | –50 mA |
| Package thermal impedance, θ _{JA} (see Note 2): DGG package | 81°C/W |
| DL package | 74°C/W |
| Storage temperature range, T _{stg} | –65°C to 150°C |

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions (see Note 3)

| | | | SN54ABTI | H16460 | SN74ABTI | H16460 | UNIT |
|---------------------|------------------------------------|-----------------|----------|--------|----------|--------|------|
| | | | MIN | MAX | MIN | MAX | UNIT |
| Vcc | Supply voltage | | 4.5 | 5.5 | 4.5 | 5.5 | V |
| VIH | High-level input voltage | | 2 | 2 | 2 | | V |
| V _{IL} | Low-level input voltage | | | 8.0 | | 0.8 | V |
| VI | Input voltage | | 0 0 | Vcc | 0 | VCC | V |
| IOH | High-level output current | | 1 | -24 | | -32 | mA |
| loL | Low-level output current | | 22 | 48 | | 64 | mA |
| Δt/Δν | Input transition rise or fall rate | Outputs enabled | 20/ | 10 | | 10 | ns/V |
| Δt/ΔV _{CC} | Power-up ramp rate | | 200 | · | 200 | | μs/V |
| TA | Operating free-air temperature | | -55 | 125 | -40 | 85 | °C |

NOTE 3: Unused control pins must be held high or low to prevent them from floating.

NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

^{2.} The package thermal impedance is calculated in accordance with EIA/JEDEC Std JESD51.

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| DAD | AMETER | TEST COL | IDITIONS | T | _A = 25°C | ; | SN54ABT | H16460 | SN74ABTI | 116460 | UNIT | |
|--------------------|----------------|--|----------------------------------|-----|---------------------|-------|---------|--------|-------------|--------|------|--|
| PAR | AWEIER | TEST CONDITIONS - | | MIN | TYP† | MAX | MIN | MAX | MIN | MAX | UNIT | |
| VIK | | $V_{CC} = 4.5 \text{ V},$ | $I_{I} = -18 \text{ mA}$ | | | -1.2 | | -1.2 | | -1.2 | V | |
| | | $V_{CC} = 4.5 \text{ V},$ | $I_{OH} = -3 \text{ mA}$ | 2.5 | | | 2.5 | | 2.5 | | | |
| \/~ | | $V_{CC} = 5 V$, | $I_{OH} = -3 \text{ mA}$ | 3 | | | 3 | | 3 | | V | |
| VOH | | V _{CC} = 4.5 V | I _{OH} = -24 mA | 2 | | | 2 | | | | V | |
| | | VCC = 4.5 V | $I_{OH} = -32 \text{ mA}$ | 2* | | | | | 2 | | | |
| VOL | | V _{CC} = 4.5 V | I _{OL} = 48 mA | | 0.36 | | | 0.5 | | | V | |
| VOL | | VCC = 4.5 V | I _{OL} = 64 mA | | | 0.55* | | | | 0.55 | V | |
| V _{hys} | | | | | 100 | | | | | | mV | |
| 1. | Control inputs | $V_{CC} = 0 \text{ to } 5.5 \text{ V},$ $V_{I} = V_{CC} \text{ or GND}$ | | | | ±1 | | ±1 | | ±1 | 4 | |
| l tı | A or B ports | $V_{CC} = 2.1 \text{ V to } 5.5$ $V_{I} = V_{CC} \text{ or GND}$ | V, | | | ±20 | | ±20 | | ±20 | μА | |
| 1.0 | A or D norto | V 45V | V _I = 0.8 V | 75 | | 500 | 75 | 500 | 75 | 500 | μА | |
| l(hold) | A or B ports | V _{CC} = 4.5 V | V _I = 2 V | -75 | | -500 | -75 | 500 | – 75 | -500 | μΑ | |
| IOZPU [‡] | ‡ | $V_{CC} = 0 \text{ to } 2.1 \text{ V},$ $V_{O} = 0.5 \text{ V to } 2.7 \text{ V}$ | ∕, OE = X | | | ±50 | , Q | ±50 | | ±50 | μΑ | |
| lozpd‡ | : | V _{CC} = 2.1 V to 0, V _O = 0.5 V to 2.7 \ | /, OE = X | | | ±50 | 570 | ±50 | | ±50 | μА | |
| l _{off} | | $V_{CC} = 0$, | V_I or $V_O \le 4.5 \text{ V}$ | | | ±100 | Q. | | | ±100 | μΑ | |
| ICEX | | V _{CC} = 5.5 V, V _O = 5.5 V | Outputs high | | | 50 | | 50 | | 50 | μА | |
| IO§ | | V _{CC} = 5.5 V, | V _O = 2.5 V | -50 | -100 | -200 | -50 | -200 | -50 | -200 | mA | |
| | | | Outputs high | | | 1.5 | | 1.5 | | 1.5 | | |
| laa | | $V_{CC} = 5.5 \text{ V},$ | A outputs low | | | 10 | | 10 | | 10 | mA | |
| Icc | | $I_O = 0$, $V_I = V_{CC}$ or GND | B outputs low | | | 32 | | 32 | | 32 | IIIA | |
| | | 1 00 | Outputs disabled | | | 1.5 | | 1.5 | | 1.5 | | |
| ∆I _{CC} ¶ | | $V_{CC} = 5.5 \text{ V}$, One in Other inputs at V_{C} | | | | 1.5 | | 1.5 | | 1.5 | mA | |
| Ci | Control inputs | V _I = 2.5 V or 0.5 V | | | 8 | | | | | | pF | |
| C _{io} | A or B ports | V _O = 2.5 V or 0.5 \ | / | | 3.5 | | | | | | pF | |

^{*} On products compliant to MIL-PRF-38535, this parameter does not apply.

[†] All typical values are at $V_{CC} = 5 \text{ V}$.

[‡] This parameter is characterized but not production tested.

[§] Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

[¶] This is the increase in supply current for each input that is at the specified TTL voltage level rather than V_{CC} or GND.

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timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| | | | | SN54ABTI | 116460 | SN74ABTI | H16460 | UNIT |
|----------|-----------------|---------------------------|------------------|----------|--------|----------|--------|------|
| | | | | MIN | MAX | MIN | MAX | UNII |
| fclock | Clock frequency | | | 0 | 160 | 0 | 160 | MHz |
| | | CLKAB high or low | | 3.8 | | 3.8 | | |
| | | CLKBA high or low | | 4.5 | | 4.5 | | |
| t_{W} | Pulse duration | LEAB1, 2, 3, or 4 high | | 2.2 | | 2.2 | | ns |
| | | LEBA high | | 2.1 | | 2.1 | | |
| | | LEB1, 2, 3, or 4 high | | 2.4 | | 2.4 | | |
| | | | A bus | 2.5 | | 2.5 | | |
| | | Before CLKAB↑ | CE_SEL0/1 | 3.2 | | 3.2 | | |
| | | | CLKENAB | 3.2 | | 3.2 | | |
| | | Before LEAB1, 2, 3, or 4↓ | A bus | 3.6 | | 3.6 | | |
| | | | B bus | 3.8 | | 3.8 | | |
| | | Before CLKBA↑ | CLKENB | 2.3 | , s | 2.3 | | |
| t_{SU} | Setup time | | CLKENBA | 2.5 | , S | 2.5 | | ns |
| | | | LEB1, 2, 3, or 4 | 4.3 | Ž. | 4.3 | | |
| | | | SEL0/1 | 4.5 | | 4.5 | | |
| | | Before LEB1, 2, 3, or 4↓ | B bus | 3.2 | | 3.2 | | |
| | | | B bus | O 4 | | 4 | | |
| | | Before LEBA↓ | LEB1, 2, 3, or 4 | 4.4 | | 4.4 | | |
| | | | SEL0/1 | 4.3 | | 4.3 | | |
| | | | A bus | 0.5 | | 0.5 | | |
| | | After CLKAB↑ | CE_SEL0/1 | 1.1 | | 1.1 | | |
| | | | CLKENAB | 0.5 | | 0.5 | | |
| | | After LEAB1, 2, 3, or 4↓ | A bus | 1.2 | | 1.2 | | |
| | | | B bus | 1.3 | | 1.3 | | |
| th | Hold time | After CLKBA↑ | CLKENB | 1 | | 1 | | ns |
| | Allei CLNDAT | | 1 | | 1 | | | |
| | | | SEL0/1 | 0 | | 0 | | |
| | | After LEB1, 2, 3, or 4↓ | B bus | 1.5 | | 1.5 | | |
| | | After LEBA↓ | B bus | 0.4 | | 0.4 | | |
| | | Alter LLDAV | SEL0/1 | 0.1 | | 0.1 | | |

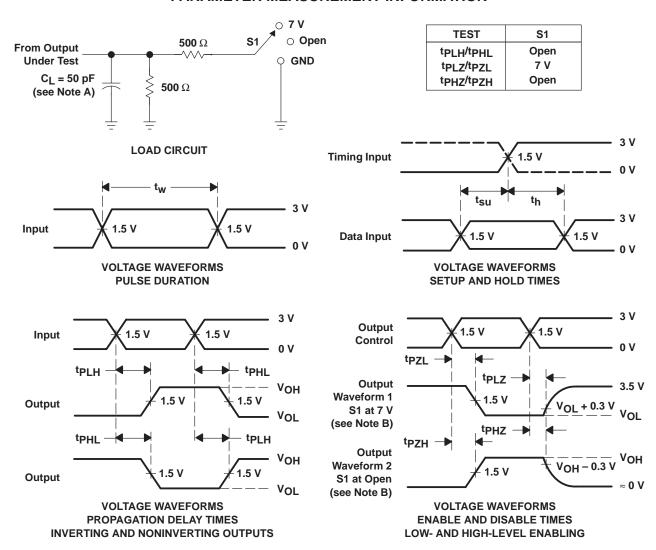
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switching characteristics over recommended ranges of supply voltage and operating free-air temperature, $C_L = 50$ pF (unless otherwise noted) (see Figure 1)

| PARAMETER | ARAMETER FROM TO | | V _C | CC = 5 V 4 = 25°C | ', : | SN54ABT | H16460 | SN74ABTI | H16460 | UNIT |
|------------------|------------------|----------|----------------|----------------------|---------|---------|--------|----------|--------|------|
| | (INFOT) | (OUTPUT) | MIN | TYP | MAX | MIN | MAX | MIN | MAX | |
| f _{max} | | | 160 | | | 160 | | 160 | | MHz |
| ^t PLH | В | А | 2.5 | 3.6 | 5.9 | 2.5 | 7.1 | 2.5 | 6.5 | ns |
| ^t PHL |] | A | 2 | 3.5 | 5.8 | 2 | 6.8 | 2 | 6.5 | 115 |
| ^t PZH | OEA | А | 1.5 | 2.8 | 4.8 | 1.5 | 5.9 | 1.5 | 5.6 | ns |
| ^t PZL | JUEA | A | 1.5 | 2.6 | 4.6 | 1.5 | 5.5 | 1.5 | 5.2 | 115 |
| ^t PHZ | | А | 2.5 | 3.8 | 5.3 | 2.5 | 6 | 2.5 | 5.9 | ns |
| ^t PLZ | OEA | A | 1.5 | 4.6 | 6.1 | 1.5 | 7 | 1.5 | 6.5 | 115 |
| ^t PLH | A | В | 2 | 3.2 | 5.2 | 2 | 6.2 | 2 | 5.7 | ns |
| ^t PHL | 7 | Ь | 1.5 | 3.1 | 5.2 | 1.5 | 6.1 | 1.5 | 5.7 | 115 |
| ^t PZH | <u> </u> | В | 1.5 | 3.3 | 5.7 | 1.5 | 6.7 | 1.5 | 6.4 | ns |
| ^t PZL | OEB | Ь | 1.5 | 3.2 | 5.5 | 1.5 | 6.6 | 1.5 | 6.3 | 115 |
| ^t PHZ | OEB | В | 3 | 4.7 | 6.3 | 3 4 | 7.1 | 3 | 7 | no |
| t _{PLZ} | OER . | Ь | 2 | 4 | 5.5 | 2 | 6.6 | 2 | 6.1 | ns |
| ^t PZH | <u></u> | В | 1.5 | 3 | 5.2 | 1.5 | 6 | 1.5 | 5.8 | ns |
| t _{PZL} | OEB1, 2, 3, 4 | Ь | 1.5 | 2.9 | 4.9 | 1.5 | 5.9 | 1.5 | 5.6 | 115 |
| ^t PHZ | | В | 2.5 | 4 | 5.7 | 2.5 | 6.2 | 2.5 | 6.1 | no |
| t _{PLZ} | OEB1, 2, 3, 4 | Ь | 1.5 | 3.5 | 4.8 | 1.5 | 5.8 | 1.5 | 5.3 | ns |
| ^t PLH | CLKBA | А | 1.5 | 4.2 | 6.7 | 1.5 | 8.1 | 1.5 | 7.4 | ns |
| ^t PHL | CLRBA | A | 1.5 | 4.4 | 6.9 | 1.5 | 8.4 | 1.5 | 7.7 | 115 |
| ^t PLH | CLKAB | В | 2 | 3.4 | 5.6 | 2 | 6.8 | 2 | 6.2 | ns |
| ^t PHL | CLRAB | В | 2 | 3.4 | 5.3 | 2 | 6.3 | 2 | 5.9 | 115 |
| ^t PLH | LEBA | А | 2 | 3 | 5 | 2 | 6.1 | 2 | 5.6 | ns |
| ^t PHL | LLDA | ^ | 2 | 3.1 | 4.8 | 2 | 5.8 | 2 | 5.3 | 119 |
| ^t PLH | LEAB1, 2, 3, 4 | В | 2 | 3.2 | 5.2 | 2 | 6.3 | 2 | 5.8 | ns |
| ^t PHL | LLAD1, 2, 3, 4 | | 2 | 3.3 | 5 | 2 | 6.1 | 2 | 5.6 | 115 |
| ^t PLH | LEBA1, 2, 3, 4 | А | 2.5 | 4 | 6.5 | 2.5 | 7.8 | 2.5 | 7.2 | ne |
| ^t PHL | | ^ | 2.5 | 4 | 6.1 | 2.5 | 7.5 | 2.5 | 6.8 | ns |
| t _{PLH} | SEL | А | 2 | 4.1 | 6.7 | 2 | 8.1 | 2 | 7.5 | ns |
| ^t PHL | | _ ^ | 2 | 3.8 | 6.2 | 2 | 7.3 | 2 | 6.9 | 115 |

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PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z $_{O}$ = 50 Ω , t_{f} \leq 2.5 ns, t_{f} \leq 2.5 ns.
- D. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

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|----------------|--------------|
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